

## EAST Search History

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L2	24	(channel and pressure and nozzle and piezoelectric and electrode near3 (upper lower top bottom) with stress and ((insulat\$3 protective protection) adj2 (film layer)) with stress and (compressive compression) near3 stress)	USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/03/12 13:19
L4	4	347/64,71,72.ccls. and (compressive compression) near4 (stress) and (compressive compression) with ((insulat\$3 protective protection) near3 (film layer)) and (electrode lead contact) with stress	US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/03/12 13:25
L6	94	347/64,71,72.ccls. and ((insulat\$3 protective protection) near3 (film layer)) with (electrode lead contact) near4 (cover\$3)	US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/03/12 13:32
L7	27	347/64,71,72.ccls. and ((insulat\$3 protective protection) near3 (film layer)) with (electrode lead contact) near4 (cover\$3)	US-PGPUB	OR	ON	2009/03/12 13:33
L10	375	347/64,71,72.ccls. and ((insulat\$3 protective protection) near3 (film layer)) with (electrode lead contact)	US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/03/12 13:50
S89	8	US-6390589-\$.DID. OR US-6869170-\$.DID. OR US-20040051763-\$.DID. OR US-20050128255-\$.DID.	US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/03/11 20:39
S93	1	"20020080213".pn. and (insulat\$3 adj2 (film layer) and compressive)	US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/03/12 12:26
S108	4	"347".clas. and (compressive compression) near4 (stress) and (compressive compression) with ((insulat\$3 protective protection) adj2 (film layer)) and (electrode lead contact) near3 stress	US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/03/12 12:47
S109	3	347/58,44,48,59,64,68,69,70,71,72.ccls. and (compressive compression) near4 (stress) and (compressive compression) with ((insulat\$3 protective protection) adj2 (film layer)) and (electrode lead contact) near3 stress	US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/03/12 12:47
S110	6	("20020024564"   "20060033778"   "20060033779"   "4596994"   "6467884"   "6485131").PN. OR ("7393084").URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2009/03/12 12:48
S111	0	S110 and (compressive compression) near4 (stress) and (compressive compression) with ((insulat\$3 protective protection) adj2 (film layer)) and (electrode lead contact) near3 stress	US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/03/12 12:49
S113	3	347/20,56-59,61-65,67.ccls. and (compressive compression) near4 (stress) and (compressive compression) with ((insulat\$3 protective protection) near3 (film layer)) and (electrode lead contact) near3 stress	US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/03/12 12:51

S114	1	(channel and pressure and nozzle and piezoelectric and electrode near3 (upper lower top bottom) and ((insulat\$3 protective protection) adj2 (film layer)) and (compressive compression) near3 stress).clm.	US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/03/12 12:54
S118	50	(channel and pressure and nozzle and piezoelectric and electrode near3 (upper lower top bottom) with stress and ((insulat\$3 protective protection) adj2 (film layer)) with stress and (compressive compression) near3 stress)	US-PGPUB	OR	ON	2009/03/12 12:56

**3/ 12/ 2009 1:59:09 PM**

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